SiJ186DP

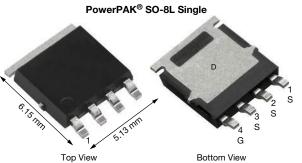
RoHS COMPLIANT

HALOGEN

FREE

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| PRODUCT SUMMARY | |
|--|--------|
| V _{DS} (V) | 60 |
| $R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V | 0.0045 |
| $R_{DS(on)}$ max. (Ω) at V_{GS} = 7.5 V | 0.0054 |
| $R_{DS(on)}$ max. (Ω) at V_{GS} = 6 V | 0.0078 |
| Q _g typ. (nC) | 15.5 |
| I _D (A) | 79.4 |
| Configuration | Single |

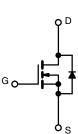
FEATURES

N-Channel 60 V (D-S) MOSFET

- TrenchFET[®] Gen IV power MOSFET
- Very low R_{DS} Q_g figure-of-merit (FOM)
- Tuned for the lowest R_{DS} Q_{oss} FOM
- 100 % R_q and UIS tested
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Synchronous rectification
- · Primary side switch
- DC/DC converter
- Motor drive switch



N-Channel MOSFET

ORDERING INFORMATION

| Package | PowerPAK SO-8L |
|---------------------------------|-----------------|
| Lead (Pb)-free and halogen-free | SiJ186DP-T1-GE3 |

- 25 °C unless otherwise noted)

| PARAMETER | | SYMBOL | LIMIT | UNIT | |
|---|------------------------|-----------------------------------|----------------------|------------|--|
| Drain-source voltage | | V _{DS} | 60 | V | |
| Gate-source voltage | | V _{GS} | ± 20 | V | |
| | T _C = 25 °C | | 79.4 | | |
| Continuous drain ourrent (T 150 °C) | T _C = 70 °C | | 63.5 | | |
| Continuous drain current (T _J = 150 °C) | T _A = 25 °C | I _D | 23 ^{b, c} | | |
| | T _A = 70 °C | | 18.4 ^{b, c} | | |
| Pulsed drain current (t = 100 µs) | | I _{DM} | 150 | A | |
| | T _C = 25 °C | | 51.8 | | |
| Continuous source-drain diode current | T _A = 25 °C | I _S | 4.5 ^{b, c} | | |
| Single pulse avalanche current | | I _{AS} | 25 | | |
| Single pulse avalanche energy | L = 0.1 mH | E _{AS} | 31.25 | mJ | |
| | T _C = 25 °C | | 57 | | |
| Manimum annual diasia atian | T _C = 70 °C | | 36 | | |
| Maximum power dissipation | T _A = 25 °C | P _D | 5 ^{b, c} | W | |
| | T _A = 70 °C | 1 1 | 3.2 ^{b, c} | | |
| Operating junction and storage temperature range | | T _J , T _{stg} | -55 to +150 | ° C | |
| Soldering recommendations (peak temperature) ^c | | | 260 | °C | |

THERMAL RESISTANCE RATINGS

| PARAMETER | | SYMBOL | TYPICAL | MAXIMUM | UNIT |
|--|--------------|-------------------|---------|---------|------|
| Maximum junction-to-ambient ^b | t ≤ 10 s | R _{thJA} | 20 | 25 | °C/W |
| Maximum junction-to-case (drain) | Steady state | R _{thJC} | 1.7 | 2.2 | C/W |

Notes а.

Package limited Surface mounted on 1" x 1" FR4 board b.

t = 10 s c.

See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection d.

Rework conditions: manual soldering with a soldering iron is not recommended for leadless components e.

f. Maximum under steady state conditions is 70 °C/W T_{C} = 25 °C

g.

S18-0824-Rev. A, 13-Aug-2018

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SiJ186DP

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--|-------------------------|--|--------|--------|--------|-------|
| Static | | | | | | |
| Drain-source breakdown voltage | V _{DS} | $V_{GS} = 0 V$, $I_{D} = 250 \mu A$ | 60 | - | - | V |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | I _D = 10 mA | - | 32 | - | |
| V _{GS(th)} temperature coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = 250 μA | - | -6.7 | - | mV/°C |
| Gate-source threshold voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$ | 2 | - | 3.6 | V |
| Gate-source leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | - | - | 100 | nA |
| | | $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$ | - | - | 1 | |
| Zero gate voltage drain current | IDSS | $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$ | - | - | 15 | μA |
| On-state drain current ^a | I _{D(on)} | $V_{DS} \ge 10$ V, $V_{GS} = 10$ V | 40 | - | - | Α |
| | | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 15 \text{ A}$ | - | 0.0037 | 0.0045 | |
| Drain-source on-state resistance ^a | R _{DS(on)} | $V_{GS} = 7.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$ | - | 0.0043 | 0.0054 | Ω |
| prward transconductance ^a ynamic ^b put capacitance utput capacitance everse transfer capacitance | | $V_{GS} = 6 V, I_D = 10 A$ | - | 0.0060 | 0.0078 | |
| Forward transconductance ^a | | V _{DS} = 15 V, I _D = 15 A | - | 54 | - | S |
| Dynamic ^b | | | | | | |
| Input capacitance | C _{iss} | | - | 1710 | - | |
| Output capacitance | C _{oss} | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | - | 445 | - | pF |
| Reverse transfer capacitance | C _{rss} | | | 29 | - | 1 |
| | Q _g - | $V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$ | - | 24.5 | 37 | |
| Total gate charge | | | - | 15.5 | 24 | |
| Gate-source charge | Q _{gs} | $V_{DS} = 30 \text{ V}, V_{GS} = 6 \text{ V}, I_{D} = 10 \text{ A}$ | - | 6.5 | - | nC |
| Gate-drain charge | Q _{gd} | | - | 4.5 | - | |
| Output charge | Q _{oss} | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$ | - | 27.5 | - | |
| Gate resistance | Rg | f = 1 MHz | 0.3 | 0.85 | 1.5 | Ω |
| Turn-on delay time | t _{d(on)} | | - | 10 | 20 | |
| Rise time | t _r | $V_{DD} = 30 \text{ V}, \text{ R}_{L} = 3 \Omega, \text{ I}_{D} \cong 10 \text{ A},$ | - | 22 | 44 | _ |
| Turn-off delay time | t _{d(off)} | $V_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$ | - | 14 | 28 | _ |
| Fall time | t _f | | - | 9 | 18 | |
| Turn-on delay time | t _{d(on)} | | - | 11 | 22 | ns |
| Rise time | t _r | $V_{DD} = 30 \text{ V}, \text{ R}_{\text{L}} = 3 \Omega, \text{ I}_{\text{D}} \cong 10 \text{ A},$ | - | 23 | 46 | _ |
| Turn-off delay time | t _{d(off)} | $V_{\text{GEN}} = 7.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$ | _ | 13 | 26 | |
| Fall time | t _f | | - | 9 | 18 | |
| Drain-Source Body Diode Characteristi | | | | 1 | Į | |
| Continuous source-drain diode current | I _S | T _C = 25 °C | - | - | 51.8 | |
| Pulse diode forward current | I _{SM} | | - | - | 150 | A |
| Body diode voltage | V _{SD} | I _S = 5 A, V _{GS} = 0 V | - | 0.77 | 1.1 | V |
| Body diode reverse recovery time | t _{rr} | | - | 44 | 88 | ns |
| Body diode reverse recovery charge | Q _{rr} | I _F = 10 A, di/dt = 100 A/μs, | - | 42 | 84 | nC |
| Reverse recovery fall time | t _a | $T_J = 25 \text{ °C}$ | - 20 - | | | |
| Reverse recovery rise time | t _a | - | - | 24 | _ | ns |

Notes

a. Pulse test; pulse width $\leq 300~\mu\text{s},~\text{duty~cycle} \leq 2~\%$

b. Guaranteed by design, not subject to production testing

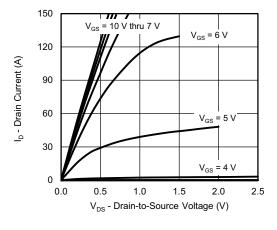
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

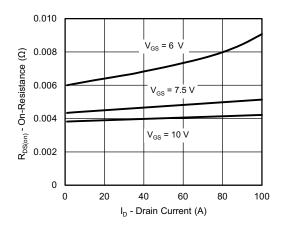
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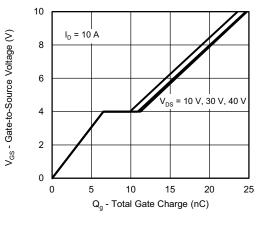
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



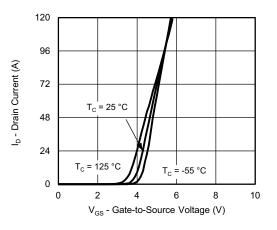
Output Characteristics



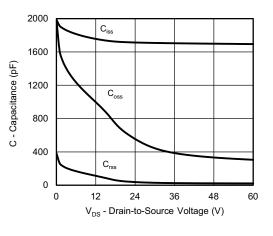
On-Resistance vs. Drain Current and Gate Voltage



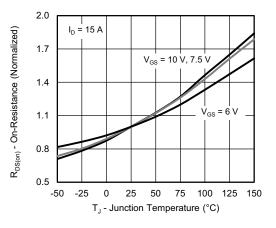
Gate Charge



Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

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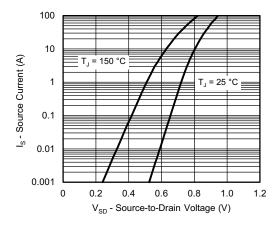
3

Document Number: 76825

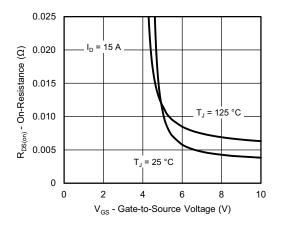
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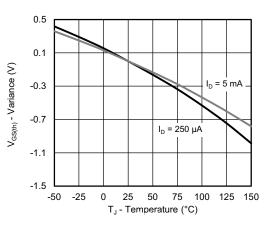
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



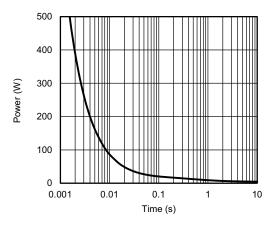
Source-Drain Diode Forward Voltage



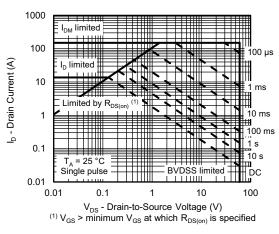
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient

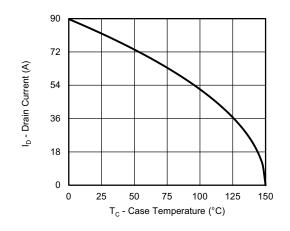


Safe Operating Area, Junction-to-Ambient

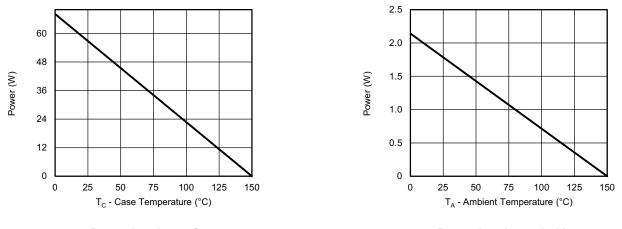
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating a



Power, Junction-to-Case

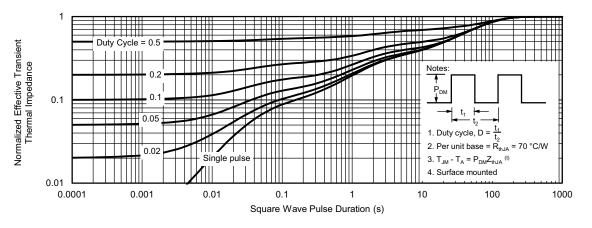
Power, Junction-to-Ambient

Note

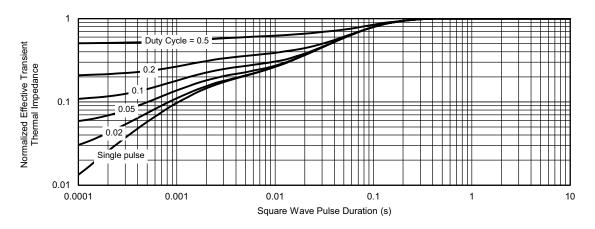
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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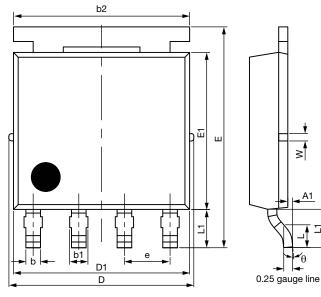


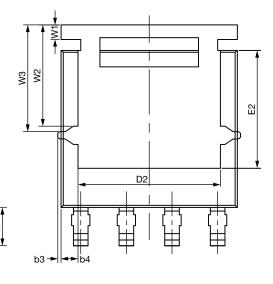


1

A1

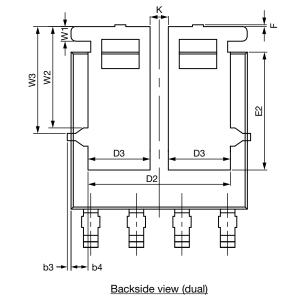
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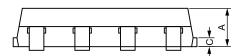




Topside view

Backside view (single)





Package Information



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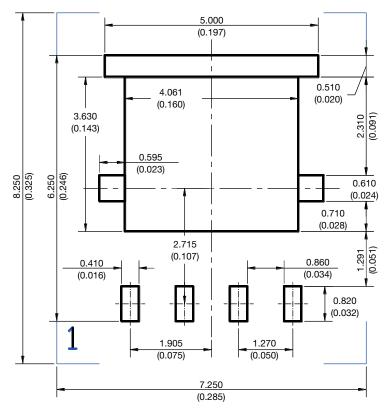
| 514 | | MILLIMETERS | | | INCHES | | | |
|------|------|-------------|-------|-----------|--------|-------|--|--|
| DIM. | MIN. | NOM. | MAX. | MIN. | MAX. | | | |
| А | 1.00 | 1.07 | 1.14 | 0.039 | 0.042 | 0.045 | | |
| A1 | 0.00 | - | 0.127 | 0.00 | - | 0.005 | | |
| b | 0.33 | 0.41 | 0.48 | 0.013 | 0.016 | 0.019 | | |
| b1 | 0.44 | 0.51 | 0.58 | 0.017 | 0.020 | 0.023 | | |
| b2 | 4.80 | 4.90 | 5.00 | 0.189 | 0.193 | 0.197 | | |
| b3 | | 0.094 | | | 0.004 | | | |
| b4 | | 0.47 | | | 0.019 | | | |
| С | 0.20 | 0.25 | 0.30 | 0.008 | 0.010 | 0.012 | | |
| D | 5.00 | 5.13 | 5.25 | 0.197 | 0.202 | 0.207 | | |
| D1 | 4.80 | 4.90 | 5.00 | 0.189 | 0.193 | 0.197 | | |
| D2 | 3.86 | 3.96 | 4.06 | 0.152 | 0.156 | 0.160 | | |
| D3 | 1.63 | 1.73 | 1.83 | 0.064 | 0.068 | 0.072 | | |
| е | | 1.27 BSC | | 0.050 BSC | | | | |
| E | 6.05 | 6.15 | 6.25 | 0.238 | 0.242 | 0.246 | | |
| E1 | 4.27 | 4.37 | 4.47 | 0.168 | 0.172 | 0.176 | | |
| E2 | 3.18 | 3.28 | 3.38 | 0.125 | 0.129 | 0.133 | | |
| F | - | - | 0.15 | - | - | 0.006 | | |
| L | 0.62 | 0.72 | 0.82 | 0.024 | 0.028 | 0.032 | | |
| L1 | 0.92 | 1.07 | 1.22 | 0.036 | 0.042 | 0.048 | | |
| К | | 0.51 | | | 0.020 | | | |
| W | | 0.23 | | | 0.009 | | | |
| W1 | 0.41 | | | 0.016 | | | | |
| W2 | 2.82 | | | 0.111 | | | | |
| W3 | 2.96 | | | 0.117 | | | | |
| θ | 0° | - | 10° | 0° | - | 10° | | |

Note

• Millimeters will gover



RECOMMENDED MINIMUM PAD FOR PowerPAK[®] SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)

Revision: 07-Feb-12



Vishay

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